



Customer Information Notification

2020020211

Issue Date: 29-Mar-2020

Effective Date: 30-Mar-2020

Dear *Emma Tempest*,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP.

For detailed information we invite you to [view this notification online](#)

This notice is NXP Company Proprietary.



Change Category

☐ Wafer Fab Process

☐ Wafer Fab Materials

☐ Wafer Fab Location

☐ Firmware

☐ Assembly Process

☐ Assembly Materials

☐ Assembly Location

☐ Other

☐ Product Marking

☐ Mechanical Specification

☐ Packing/Shipping/Labeling

☐ Test Location

☐ Test Process

☐ Test Equipment

☐ Design

☒ Errata

☐ Electrical spec./Test coverage

Errata Update for
S32R274 (Rev 3),
S32R264 (Rev 2) and
S32R372 (Rev 3)
Products

Description

NXP Semiconductors announces errata updates for S32R274 to Rev 3, for S32R372 to Rev 3 and for S32R264 to Rev 2. The revision history included in the updated documents provide a detailed description of the changes.

The S32R274 errata Rev 3 is attached to this notice and can be found at:

https://www.nxp.com/products/processors-and-microcontrollers/power-architecture/s32r-radar-mcus/s32r-radar-microcontroller-s32r27-automotive-industrial-radar-applications:S32R27?tab=Documentation_Tab

The S32R372 errata Rev 3 is attached to this notice and can be found at:

https://www.nxp.com/products/processors-and-microcontrollers/power-architecture/s32r-radar-mcus/s32r-radar-microcontroller-s32r37-automotive-industrial-radar-applications:S32R37?tab=Documentation_Tab

The S32R264 errata Rev 2 is attached to this notice and can be obtained from the NXP customer program manager.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02

Reason

The errata have been updated to correct errors and / or provide additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No changes made to the current production devices. The errata describe existing conditions identified on current production devices. There are potential hardware/software implications to customers.

Data Sheet Revision

No impact to existing datasheet

Additional information

Affected products and sales history information: see attached file

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name NXP Technical Support

e-mail address tech.support@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

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